

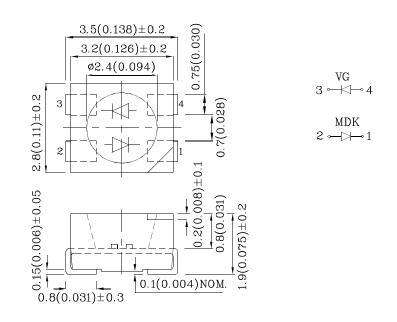
3.5x2.8mm PLCC4 SMD LED

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package: 1500pcs / reel
- \bullet Moisture sensitivity level : level 3
- \bullet RoHS compliant







Notes:

1. All dimensions are in millimeters (inches).

- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		MDK (AlGaInP)	VG (AlGaInP)	Unit
Reverse Voltage	V_{R}	5	5	V
Forward Current	$I_{\rm F}$	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	150	mA
Power Dissipation	P_{D}	75	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics (T _A =25°C)		MDK (AlGaInP)	VG (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	1.95	2.1	v
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.5	2.5	v
Reverse Current (Max.) (V _R =5V)	I_R	10	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λP	650	574	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	630	570	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle\lambda$	28	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMDKVG45S —	Red	AlGaInP	Water Clear -	200	317	650	120°
	Green	AlGaInP		40	79	574	

XDSB4882 V2 Layout: Maggie L.

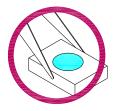


3.5x2.8mm PLCC4 SMD LED

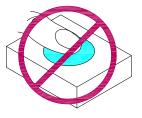
Handling Precautions

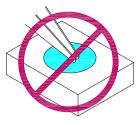
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

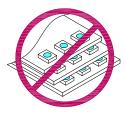


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



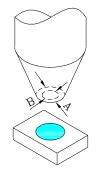


3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



4.1. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

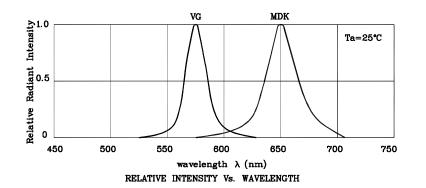
4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

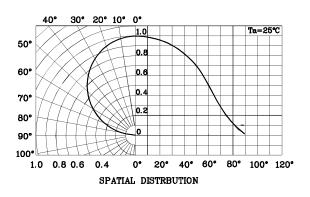


5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

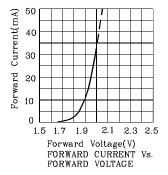
P. 2/5

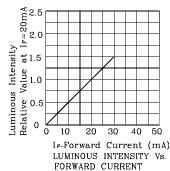


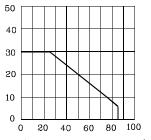




♦ MDK

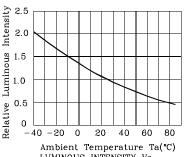


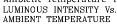




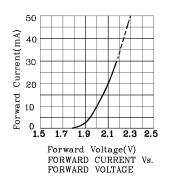
Forward Current(mA)

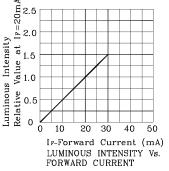
Ambient Temperature Ta(°C) FORWARD CURRENT DERATING CURVE

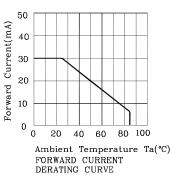


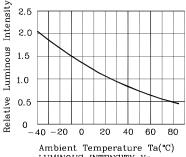


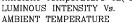
♦ VG







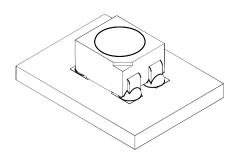




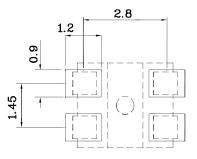


LED is recommended for reflow soldering and soldering profile is shown below.

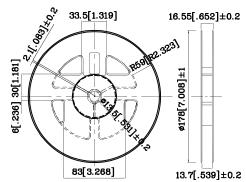
***** The device has a single mounting surface. The device must be mounted according to the specifications.



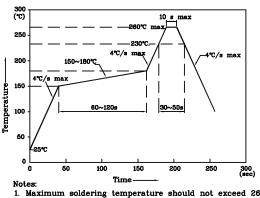
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension

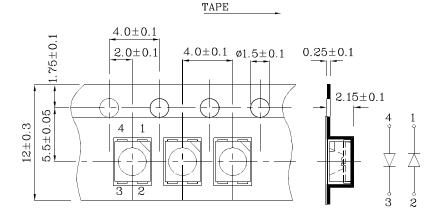


Reflow Soldering Profile for SMD Products (Pb-Free Components)



- Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C З. Do not put stress to the epoxy resin during
- high temperatures conditions

Tape Specification (Units : mm)





Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

Apr 18,2011

XDSB4882 V2 Layout: Maggie L.



PACKING & LABEL SPECIFICATIONS

